

Vishay Siliconix

# P-Channel 30 V (D-S) MOSFET



| PRODUCT SUMMARY   |                     |  |  |  |  |  |
|---|---------------------|--|--|--|--|--|
| V <sub>DS</sub> (V)   | -30                 |  |  |  |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -10 \text{ V}$  | 0.0079              |  |  |  |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$ | 0.0108              |  |  |  |  |  |
| Q <sub>g</sub> typ. (nC)                                    | 44                  |  |  |  |  |  |
| I <sub>D</sub> (A)  | -16 <sup>a, e</sup> |  |  |  |  |  |
| Configuration   | Single              |  |  |  |  |  |

#### **FEATURES**

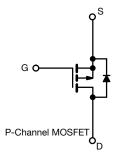
- TrenchFET® Gen III p-channel power MOSFET
- 100% R<sub>g</sub> tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- Adapter switch
- · Load switch
- Power management in battery-operated, mobile and wearable devices



| ORDERING INFORMATION            |                 |  |  |  |
|---------------------------------|-----------------|--|--|--|
| Package                         | SO-8            |  |  |  |
| Lead (Pb)-free and halogen-free | Si4103DY-T1-GE3 |  |  |  |

| PARAMETER  |                        | SYMBOL                            | LIMIT                 | UNIT |  |
|--|------------------------|-----------------------------------|-----------------------|------|--|
| Drain-source voltage                               |                        | V <sub>DS</sub>                   | -30                   | V    |  |
| Gate-source voltage                                |                        | V <sub>GS</sub>                   | ± 20                  | V    |  |
|  | T <sub>C</sub> = 25 °C |                                   | -16 <sup>a</sup>      |      |  |
| Continuous dusin suurent /T 150 %C)                | T <sub>C</sub> = 70 °C |                                   | -16 <sup>a</sup>      |      |  |
| Continuous drain current (T <sub>J</sub> = 150 °C) | T <sub>A</sub> =25 °C  | I <sub>D</sub>                    | -14 <sup>b, c</sup>   |      |  |
|  | T <sub>A</sub> = 70 °C |                                   | -11.3 <sup>b, c</sup> | Α    |  |
| Pulsed drain current (t = 100 μs)                  |                        | I <sub>DM</sub>                   | -80 <sup>a</sup>      |      |  |
| Continuous source-drain diode current              | T <sub>C</sub> = 25 °C | ,                                 | -4.3                  |      |  |
|  | T <sub>A</sub> = 70 °C | I <sub>S</sub>                    | -2.1 <sup>b, c</sup>  |      |  |
| Maximum power dissipation                          | T <sub>C</sub> = 25 °C |                                   | 5.2                   |      |  |
|  | T <sub>C</sub> = 70 °C |                                   | 3.3                   | 14/  |  |
|  | T <sub>A</sub> = 25 °C | P <sub>D</sub>                    | 2.5 b, c              | W    |  |
|  | T <sub>A</sub> = 70 °C |                                   | 1.6 <sup>b, c</sup>   |      |  |
| Operating junction and storage temperature range   |                        | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150           | °C   |  |
| Soldering recommendations (peak tempera            |                        | 260                               |                       |      |  |

| THERMAL RESISTANCE RATINGS       |              |                   |         |      |        |  |  |
|----------------------------------|--------------|-------------------|---------|------|--------|--|--|
| PARAMETER                        | SYMBOL       | TYPICAL           | MAXIMUM | UNIT |        |  |  |
| Maximum junction-to-ambient b, d | t ≤ 10 s     | R <sub>thJA</sub> | 40      | 50   | °C/W   |  |  |
| Maximum junction-to-foot (drain) | Steady state | $R_{thJF}$        | 20      | 24   | - °C/W |  |  |

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. Maximum under steady state conditions is 85 °C/W
- e.  $T_C = 25$  °C



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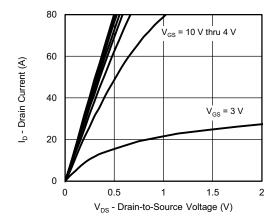
| PARAMETER                                     | SYMBOL                  | TEST CONDITIONS  | MIN. | TYP.   | MAX.   | UNIT        |  |
|---|-------------------------|--|------|--------|--------|-------------|--|
| Static  |                         |  |      |        | •      |             |  |
| Drain-source breakdown voltage                | $V_{DS}$                | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$   | -30  | -      | -      | V           |  |
| V <sub>DS</sub> temperature coefficient       | $\Delta V_{DS}/T_{J}$   | 1 050 A  | -    | -23    | -      | \/00        |  |
| V <sub>GS(th)</sub> temperature coefficient   | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = -250 μA   | -    | 5      | -      | mV/°C       |  |
| Gate-source threshold voltage                 | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}, I_D = -250 \mu A$  | -1   | -      | -2     | V           |  |
| Gate-source leakage                           | I <sub>GSS</sub>        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$  | -    | -      | ± 100  | nA          |  |
|   |                         | $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$   | -    | -      | -1     | μА          |  |
| Zero gate voltage drain current               | I <sub>DSS</sub>        | V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C                     | -    | -      | -10    |             |  |
| On-state drain current <sup>a</sup>           | I <sub>D(on)</sub>      | $V_{DS} \le -5 \text{ V}, V_{GS} = 0 \text{ V}$  | -5   | -      | -      | Α           |  |
| Due in account on state west to account 2     | Б                       | $V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$  | -    | 0.0067 | 0.0079 | Ω           |  |
| Drain-source on-state resistance <sup>a</sup> | R <sub>DS(on)</sub>     | $V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$  | -    | 0.0090 | 0.0108 |             |  |
| Forward transconductance <sup>a</sup>         | 9 <sub>fs</sub>         | $V_{DS} = -10 \text{ V}, I_{D} = -20 \text{ A}$  | -    | 60     | -      | S           |  |
| Dynamic <sup>b</sup>                          |                         |  | ·    |        | •      | •           |  |
| Input capacitance                             | C <sub>iss</sub>        |  | -    | 5200   | -      | pF          |  |
| Output capacitance                            | C <sub>oss</sub>        | $V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$                          | -    | 535    | -      |             |  |
| Reverse transfer capacitance                  | C <sub>rss</sub>        |  | -    | 470    | -      |             |  |
| ·   | Qg                      | $V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$                      | -    | 92     | 140    | nC          |  |
| Total gate charge                             |                         | $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -10 \text{ A}$                   | -    | 44     | 66     |             |  |
| Gate-source charge                            | Q <sub>gs</sub>         | V 45VV 45VI 40A  | -    | 12.1   | -      |             |  |
| Gate-drain charge                             | Q <sub>qd</sub>         | $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -10 \text{ A}$                   | -    | 14.8   | -      |             |  |
| Gate resistance                               | R <sub>q</sub>          | f = 1 MHz  | 0.8  | 3.8    | 7.6    | Ω           |  |
| Turn-on delay time                            | t <sub>d(on)</sub>      |  | -    | 57     | 120    |             |  |
| Rise time                                     | t <sub>r</sub>          | $V_{DD} = -15 \text{ V}, R_{\perp} = 3 \Omega, I_{D} \cong -5 \text{ A},$                  | -    | 38     | 80     | 1           |  |
| Turn-off delay time                           | t <sub>d(off)</sub>     | $V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$   | -    | 55     | 110    |             |  |
| Fall time                                     | t <sub>f</sub>          |  | -    | 28     | 60     | 1           |  |
| Turn-on delay time                            | t <sub>d(on)</sub>      |  | -    | 11     | 20     | ns          |  |
| Rise time                                     | t <sub>r</sub>          | $V_{DD} = -15 \text{ V}, R_1 = 3 \Omega, I_D \cong -5 \text{ A},$                          | -    | 17     | 35     | -<br>-<br>- |  |
| Turn-off delay time                           | t <sub>d(off)</sub>     | $V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$  | -    | 78     | 160    |             |  |
| Fall time                                     | t <sub>f</sub>          |  | -    | 26     | 50     |             |  |
| <b>Drain-Source Body Diode Characteristic</b> | cs                      |  | ·    |        | •      | •           |  |
| Continuous source-drain diode current         | I <sub>S</sub>          | T <sub>C</sub> = 25 °C   | -    | -      | -4.3   |             |  |
| Pulse diode forward current                   | I <sub>SM</sub>         |  | -    | -      | -80    | A           |  |
| Body diode voltage                            | V <sub>SD</sub>         | I <sub>S</sub> = -5 A, V <sub>GS</sub> = 0 V   | -    | -0.8   | -1.2   | V           |  |
| Body diode reverse recovery time              | t <sub>rr</sub>         |  | -    | 31     | 60     | ns          |  |
| Body diode reverse recovery charge            | Q <sub>rr</sub>         |  | -    | 20     | 40     | nC          |  |
| Reverse recovery fall time                    | t <sub>a</sub>          | $I_F = -5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ | -    | 13     | -      |             |  |
| Reverse recovery rise time                    | t <sub>b</sub>          |  | -    | 18     | _      | ns          |  |

#### Notes

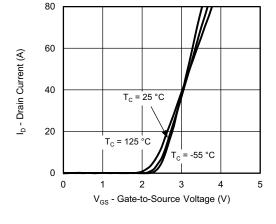
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

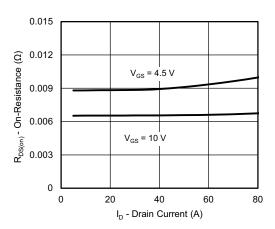




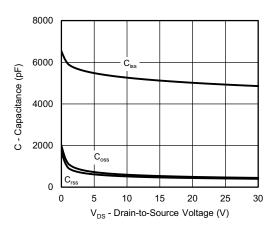
#### **Output Characteristics**



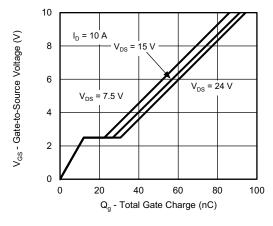
**Transfer Characteristics** 



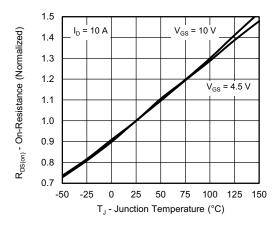
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

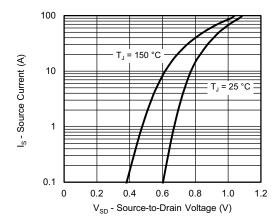


Gate Charge

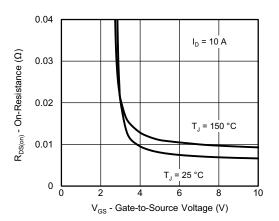


On-Resistance vs. Junction Temperature

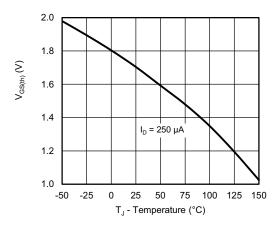




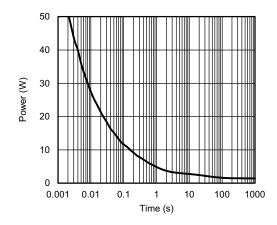
Source-Drain Diode Forward Voltage



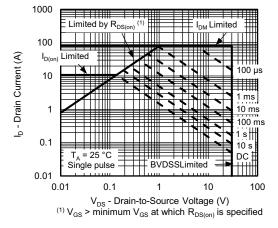
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 

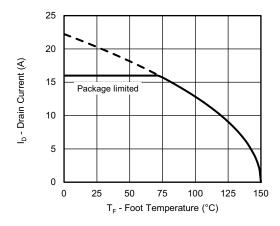


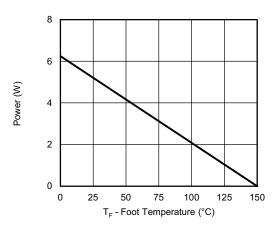
Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient







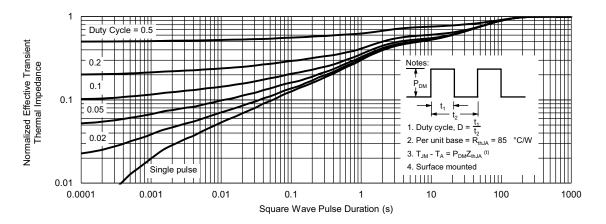
Current Derating a

Power, Junction-to-Foot

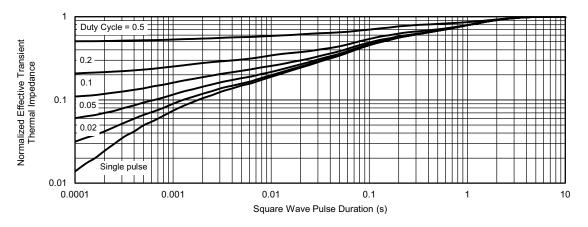
#### Note

a. The power dissipation  $P_D$  is based on  $T_J$  max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







|                                | MILLIM | IETERS | INCHES    |       |  |  |
|--------------------------------|--------|--------|-----------|-------|--|--|
| DIM                            | Min    | Max    | Min       | Max   |  |  |
| Α                              | 1.35   | 1.75   | 0.053     | 0.069 |  |  |
| A <sub>1</sub>                 | 0.10   | 0.20   | 0.004     | 0.008 |  |  |
| В                              | 0.35   | 0.51   | 0.014     | 0.020 |  |  |
| С                              | 0.19   | 0.25   | 0.0075    | 0.010 |  |  |
| D                              | 4.80   | 5.00   | 0.189     | 0.196 |  |  |
| Е                              | 3.80   | 4.00   | 0.150     | 0.157 |  |  |
| е                              | 1.27   | BSC    | 0.050 BSC |       |  |  |
| Н                              | 5.80   | 6.20   | 0.228     | 0.244 |  |  |
| h                              | 0.25   | 0.50   | 0.010     | 0.020 |  |  |
| L                              | 0.50   | 0.93   | 0.020     | 0.037 |  |  |
| q                              | 0°     | 8°     | 0°        | 8°    |  |  |
| S                              | 0.44   | 0.64   | 0.018     | 0.026 |  |  |
| ECN: C-06527-Rev. I. 11-Sep-06 |        |        |           |       |  |  |

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# LON NOTE



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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